

Features

- RoHS compliant*
- SMB package
- Surface mount
- High current capability



CD214B-B320 ~ B360 Schottky Barrier Rectifier Chip Diode

General Information

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components.

Bourns offers Schottky Rectifier Diodes for rectification applications, in compact chip package DO-214AA (SMB) size format, which offer PCB real estate savings and are considerably smaller than competitive parts. The Schottky Rectifier Diodes offer a forward current of 3 A with a choice of repetitive peak reverse voltage of 20 V up to 60 V.

Bourns® Chip Diodes conform to JEDEC standards, are easy to handle with standard pick and place equipment and their flat configuration minimizes roll away.

Electrical Characteristics (@ T_A = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CD214B-				Unit	
		B320	B330	B340	B350	B360	
Forward Voltage (Max.) (I _f = 3 A)	V _F	0.5	0.5	0.5	0.7	0.7	V
Typical Junction Capacitance*	C _T	250			pF		
Reverse Current (Max.) at Rated V _R)	۱ _R	0.5		mA			

Measured at 1.0 MHz and applied reverse voltage of 4.0 V DC.

Absolute Ratings (@ T_A = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CD214B-				Unit	
		B320	B330	B340	B350	B360	
Repetitive Peak Reverse Voltage	V _{RRM}	20	30	40	50	60	V
Reverse Voltage	V _R	20	30	40	50	60	V
Maximum RMS Voltage	V _{RMS}	14	21	28	35	42	V
Avg. Forward Current	I _o	3		Α			
Forward Current, Surge Peak (60 Hz, 1 cycle)	l surge	100			A		
Typical Thermal Resistance**	R _{ejl}	10			°C/W		
Storage Temperature	T _{STG}	-55 to +150		°C			
Junction Temperature	T	-55 to +125			°C		

** Thermal resistance junction to lead.

How To Order



*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8. 2011. Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.

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Dimension	SMB (DO-214AA)
Α	4.06 - 4.57
	(0.160 - 0.180)
В	3.30 - 3.94
D	(0.130 - 0.155)
С	1.96 - 2.21
	(0.078 - 0.087)
D	0.15 - 0.31
	(0.006 - 0.112)
F	5.21 - 5.59
	(0.205 - 0.220)
F	0.05 - 0.20
F	(0.002 - 0.008)
G	2.01 - 2.62
G	(0.080 - 0.103)
н	0.76 - 1.52
	(0.030 - 0.060)

DIMENSIONS: $\frac{MM}{(INCHES)}$

Recommended Pad Layout





DIMENSIONS: $\frac{MM}{(INCHES)}$

Dimension	SMA (DO-214AC)
А	<u>2.90</u> (0.114)
В	<u>3.00</u> (0.118)
С	<u>2.30</u> (0.091)

Physical Specifications

Case	
Polarity	Indicated by cathode band
Weight	0.003 ounces / 0.093 grams

Typical Part Marking

CD214B-B320	P 32	0B
CD214B-B330	B 33	0B
CD214B-B340	P 34	0B
CD214B-B350	P 35	0B
CD214B-B360	P 36	0B

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20

10

100

50

Rating and Characteristic Curves



Typical Forward Characteristics







2

Maximum Non-Repetitive Surge Current

Pulse Width 8.3 ms

Single Half Sine-Wave

(JEDEC Method)

5

120

100

80

60

40

20

0

Peak Forward Surge Current (Amps)



Reverse Voltage (Volts)

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CD214B-B320 ~ B360 Schottky Barrier Rectifier Chip Diode 3300

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Packaging Information

The product will be dispensed in Tape and Reel format (see diagram below).





Direction of Feed

Devices are packed in accordance with EIA standard RS-481-A and specifications shown here.

Item	Symbol	SMB (DO-214AA)
Carrier Width	A	$\frac{4.94 \pm 0.10}{(0.194 \pm 0.004)}$
Carrier Length	В	$\frac{(0.194 \pm 0.004)}{5.57 \pm 0.10}$
Carrier Depth	С	$\frac{2.36 \pm 0.10}{(0.093 \pm 0.004)}$
Sprocket Hole	d	$\frac{1.55 \pm 0.05}{(0.061 \pm 0.002)}$
Reel Outside Diameter	D	(<u>330</u> (<u>12.992</u>)
Reel Inner Diameter	D ₁	<u>50.0</u> (1.969) MIN.
Feed Hole Diameter	D ₂	$\frac{13.0 \pm 0.20}{(0.512 \pm 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$
Punch Hole Position	F	$\frac{5.50 \pm 0.05}{(0.217 \pm 0.002)}$
Punch Hole Pitch	Р	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Sprocket Hole Pitch	Po	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Embossment Center	P ₁	$\frac{2.00 \pm 0.05}{(0.079 \pm 0.002)}$
Overall Tape Thickness	Т	$\frac{0.30 \pm 0.10}{(0.012 \pm 0.004)}$
Tape Width	W	$\frac{12.00 \pm 0.20}{(0.472 \pm 0.008)}$
Reel Width	W ₁	<u>18.4</u> (0.724) MAX.
Quantity per Reel		3,000

REV. 01/18

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